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Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	POR, WDT
Number of I/O	12
Program Memory Size	3KB (2K x 12)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	73 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	18-DIP (0.300", 7.62mm)
Supplier Device Package	18-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16c58b-04e-p

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TABLE 1-1: PIC16C5X FAMILY OF DEVICES

Features	PIC16C54	PIC16CR54	PIC16C55	PIC16C56	PIC16CR56
Maximum Operation Frequency	40 MHz	20 MHz	40 MHz	40 MHz	20 MHz
EPROM Program Memory (x12 words)	512	—	512	1K	—
ROM Program Memory (x12 words)	—	512	—	—	1K
RAM Data Memory (bytes)	25	25	24	25	25
Timer Module(s)	TMR0	TMR0	TMR0	TMR0	TMR0
I/O Pins	12	12	20	12	12
Number of Instructions	33	33	33	33	33
Packages	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	28-pin DIP, SOIC; 28-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP	18-pin DIP, SOIC; 20-pin SSOP
All PIC [®] Family devices have Power-on I/O current capability.	Reset, selectat	ble Watchdog Ti	mer, selectable	Code Protect a	nd high

PIC16C58 Features **PIC16C57** PIC16CR57 PIC16CR58 Maximum Operation Frequency 20 MHz 40 MHz 40 MHz 20 MHz EPROM Program Memory (x12 words) 2K 2K ____ _ ROM Program Memory (x12 words) 2K 2K _ _ RAM Data Memory (bytes) 72 72 73 73 Timer Module(s) TMR0 TMR0 TMR0 TMR0 I/O Pins 20 20 12 12 Number of Instructions 33 33 33 33 28-pin DIP, SOIC; 28-pin DIP, SOIC; 18-pin DIP, SOIC; 18-pin DIP, SOIC; Packages 28-pin SSOP 28-pin SSOP 20-pin SSOP 20-pin SSOP All PIC® Family devices have Power-on Reset, selectable Watchdog Timer, selectable Code Protect and high I/O current capability.

NOTES:

4.3 External Crystal Oscillator Circuit

Either a prepackaged oscillator or a simple oscillator circuit with TTL gates can be used as an external crystal oscillator circuit. Prepackaged oscillators provide a wide operating range and better stability. A welldesigned crystal oscillator will provide good performance with TTL gates. Two types of crystal oscillator circuits can be used: one with parallel resonance, or one with series resonance.

Figure 4-3 shows an implementation example of a parallel resonant oscillator circuit. The circuit is designed to use the fundamental frequency of the crystal. The 74AS04 inverter performs the 180-degree phase shift that a parallel oscillator requires. The 4.7 k Ω resistor provides the negative feedback for stability. The 10 k Ω potentiometers bias the 74AS04 in the linear region. This circuit could be used for external oscillator designs.

FIGURE 4-3: EXAMPLE OF EXTERNAL PARALLEL RESONANT CRYSTAL OSCILLATOR CIRCUIT (USING XT, HS OR LP OSCILLATOR MODE)



Figure 4-4 shows a series resonant oscillator circuit. This circuit is also designed to use the fundamental frequency of the crystal. The inverter performs a 180-degree phase shift in a series resonant oscillator circuit. The 330 k Ω resistors provide the negative feedback to bias the inverters in their linear region.









6.7 Indirect Data Addressing; INDF and FSR Registers

The INDF Register is not a physical register. Addressing INDF actually addresses the register whose address is contained in the FSR Register (FSR is a *pointer*). This is indirect addressing.

EXAMPLE 6-1: INDIRECT ADDRESSING

- Register file 08 contains the value 10h
- Register file 09 contains the value 0Ah
- Load the value 08 into the FSR Register
- A read of the INDF Register will return the value of 10h
- Increment the value of the FSR Register by one (FSR = 09h)
- A read of the INDF register now will return the value of 0Ah.

Reading INDF itself indirectly (FSR = 0) will produce 00h. Writing to the INDF Register indirectly results in a no-operation (although STATUS bits may be affected).

A simple program to clear RAM locations 10h-1Fh using indirect addressing is shown in Example 6-2.

EXAMPLE 6-2:

HOW TO CLEAR RAM USING INDIRECT ADDRESSING

	MOVLW	H'10'	;initialize pointer
	MOVWF	FSR	; to RAM
NEXT	CLRF	INDF	;clear INDF Register
	INCF	FSR,F	;inc pointer
	BTFSC	FSR,4	;all done?
	GOTO	NEXT	;NO, clear next
CONTINUE			
	:		;YES, continue

The FSR is either a 5-bit (PIC16C54, PIC16CR54, PIC16C55, PIC16C56, PIC16CR56) or 7-bit (PIC16C57, PIC16CR57, PIC16CR58, PIC16CR58) wide register. It is used in conjunction with the INDF Register to indirectly address the data memory area.

The FSR<4:0> bits are used to select data memory addresses 00h to 1Fh.

PIC16C54, PIC16CR54, PIC16C55, PIC16C56, PIC16CR56: These do not use banking. FSR<6:5> bits are unimplemented and read as '1's.

PIC16C57, **PIC16CR57**, **PIC16C58**, **PIC16CR58**: FSR<6:5> are the bank select bits and are used to select the bank to be addressed (00 = bank 0, 01 = bank 1, 10 = bank 2, 11 = bank 3).



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7.0 I/O PORTS

As with any other register, the I/O Registers can be written and read under program control. However, read instructions (e.g., MOVF PORTB, W) always read the I/O pins independent of the pin's input/output modes. On RESET, all I/O ports are defined as input (inputs are at hi-impedance) since the I/O control registers (TRISA, TRISB, TRISC) are all set.

7.1 PORTA

PORTA is a 4-bit I/O Register. Only the low order 4 bits are used (RA<3:0>). Bits 7-4 are unimplemented and read as '0's.

7.2 PORTB

PORTB is an 8-bit I/O Register (PORTB<7:0>).

7.3 PORTC

PORTC is an 8-bit I/O Register for PIC16C55, PIC16C57 and PIC16CR57.

PORTC is a General Purpose Register for PIC16C54, PIC16CR54, PIC16CR56, PIC16CR56, PIC16CS8 and PIC16CR58.

7.4 TRIS Registers

The Output Driver Control Registers are loaded with the contents of the W Register by executing the TRIS f instruction. A '1' from a TRIS Register bit puts the corresponding output driver in a hi-impedance (input) mode. A '0' puts the contents of the output data latch on the selected pins, enabling the output buffer.

Note:	A read of the ports reads the pins, not the
	output data latches. That is, if an output
	driver on a pin is enabled and driven high,
	but the external system is holding it low, a
	read of the port will indicate that the pin is
	low.

The TRIS Registers are "write-only" and are set (output drivers disabled) upon RESET.

TABLE 7-1:	SUMMARY O	F PORT	REGISTERS
			LOIOI LIVO

Value on Value on Bit 4 Bit 3 Bit 1 Bit 0 MCLR and Address Name Bit 7 Bit 6 Bit 5 Bit 2 Power-On Reset WDT Reset TRIS N/A I/O Control Registers (TRISA, TRISB, TRISC) 1111 1111 1111 1111 05h PORTA RA3 RA2 RA1 RA0 _ _ _ _ xxxx _ _ _ _ uuuu PORTB 06h RB7 RB6 RB5 RB4 RB3 RB2 RB1 RB0 XXXX XXXX uuuu uuuu 07h PORTC RC7 RC6 RC5 RC4 RC3 RC2 RC1 RC0 XXXX XXXX uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', Shaded cells = unimplemented, read as '0'

7.5 I/O Interfacing

The equivalent circuit for an I/O port pin is shown in Figure 7-1. All ports may be used for both input and output operation. For input operations these ports are non-latching. Any input must be present until read by an input instruction (e.g., MOVF PORTB, W). The outputs are latched and remain unchanged until the output latch is rewritten. To use a port pin as output, the corresponding direction control bit (in TRISA, TRISB, TRISC) must be cleared (= 0). For use as an input, the corresponding TRIS bit must be set. Any I/O pin can be programmed individually as input or output.

FIGURE 7-1: EQUIVALENT CIRCUIT FOR A SINGLE I/O PIN



8.0 TIMER0 MODULE AND TMR0 REGISTER

The Timer0 module has the following features:

- 8-bit timer/counter register, TMR0
 - Readable and writable
- 8-bit software programmable prescaler
- · Internal or external clock select
- Edge select for external clock

Figure 8-1 is a simplified block diagram of the Timer0 module, while Figure 8-2 shows the electrical structure of the Timer0 input.

Timer mode is selected by clearing the T0CS bit (OPTION<5>). In Timer mode, the Timer0 module will increment every instruction cycle (without prescaler). If TMR0 register is written, the increment is inhibited for the following two cycles (Figure 8-3 and Figure 8-4). The user can work around this by writing an adjusted value to the TMR0 register.



Counter mode is selected by setting the T0CS bit (OPTION<5>). In this mode, Timer0 will increment either on every rising or falling edge of pin T0CKI. The incrementing edge is determined by the source edge select bit T0SE (OPTION<4>). Clearing the T0SE bit selects the rising edge. Restrictions on the external clock input are discussed in detail in Section 8.1.

Note: The prescaler may be used by either the Timer0 module or the Watchdog Timer, but not both.

The prescaler assignment is controlled in software by the control bit PSA (OPTION<3>). Clearing the PSA bit will assign the prescaler to Timer0. The prescaler is not readable or writable. When the prescaler is assigned to the Timer0 module, prescale values of 1:2, 1:4,..., 1:256 are selectable. Section 8.2 details the operation of the prescaler.

A summary of registers associated with the Timer0 module is found in Table 8-1.



FIGURE 8-2: ELECTRICAL STRUCTURE OF TOCKI PIN



8.2 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer (WDT), respectively (Section 9.2.1). For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the WDT, but not both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT, and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., CLRF 1, MOVWF 1, BSF 1, x, etc.) will clear the prescaler. When assigned to WDT, a CLRWDT instruction will clear the prescaler along with the WDT. The prescaler is neither readable nor writable. On a RESET, the prescaler contains all '0's.

8.2.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed "on the fly" during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 8-1) must be executed when changing the prescaler assignment from Timer0 to the WDT.

EXAMPLE 8-1: CHANGING PRESCALER (TIMER0→WDT)

CLRWDT	;Clear WDT
CLRF TMR0	;Clear TMR0 & Prescaler
MOVLW B'00xx1111'	;Last 3 instructions in
	this example
OPTION	;are required only if
	;desired
CLRWDT	;PS<2:0> are 000 or
	;001
MOVLW B'00xx1xxx'	;Set Prescaler to
OPTION	;desired WDT rate

To change prescaler from the WDT to the Timer0 module, use the sequence shown in Example 8-2. This sequence must be used even if the WDT is disabled. A CLRWDT instruction should be executed before switching the prescaler.

EXAMPLE 8-2: CHANGING PRESCALER (WDT \rightarrow TIMER0)

CLRWDT		;Clear WDT and
		;prescaler
MOVLW	B'xxxx0xxx'	;Select TMR0, new
		;prescale value and
		;clock source

OPTION

9.2 Watchdog Timer (WDT)

The Watchdog Timer (WDT) is a free running on-chip RC oscillator which does not require any external components. This RC oscillator is separate from the RC oscillator of the OSC1/CLKIN pin. That means that the WDT will run even if the clock on the OSC1/CLKIN and OSC2/CLKOUT pins have been stopped, for example, by execution of a SLEEP instruction. During normal operation or SLEEP, a WDT Reset or Wake-up Reset generates a device RESET.

The $\overline{\text{TO}}$ bit (STATUS<4>) will be cleared upon a Watchdog Timer Reset (Section 6.3).

The WDT can be permanently disabled by programming the configuration bit WDTE as a '0' (Section 9.1). Refer to the PIC16C5X Programming Specifications (Literature Number DS30190) to determine how to access the configuration word.

9.2.1 WDT PERIOD

An 8-bit counter is available as a prescaler for the Timer0 module (Section 8.2), or as a postscaler for the Watchdog Timer (WDT), respectively. For simplicity, this counter is being referred to as "prescaler" throughout this data sheet. Note that the prescaler may be used by either the Timer0 module or the WDT, but not

both. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the WDT, and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine prescaler assignment and prescale ratio (Section 6.4).

The WDT has a nominal time-out period of 18 ms (with no prescaler). If a longer time-out period is desired, a prescaler with a division ratio of up to 1:128 can be assigned to the WDT (under software control) by writing to the OPTION register. Thus, time-out a period of a nominal 2.3 seconds can be realized. These periods vary with temperature, VDD and part-to-part process variations (see Device Characterization).

Under worst case conditions (VDD = Min., Temperature = Max., WDT prescaler = 1:128), it may take several seconds before a WDT time-out occurs.

9.2.2 WDT PROGRAMMING CONSIDERATIONS

The CLRWDT instruction clears the WDT and the prescaler, if assigned to the WDT, and prevents it from timing out and generating a device RESET.

The SLEEP instruction RESETS the WDT and the prescaler, if assigned to the WDT. This gives the maximum SLEEP time before a WDT Wake-up Reset.



TABLE 9-1: SUMMARY OF REGISTERS ASSOCIATED WITH THE WATCHDOG TIMER

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-On Reset	<u>Value</u> on MCLR and WDT Reset
N/A	OPTION	—	—	Tosc	Tose	PSA	PS2	PS1	PS0	11 1111	11 1111

Legend: u = unchanged, - = unimplemented, read as '0'. Shaded cells not used by Watchdog Timer.

CALL	Subroutine Call
Syntax:	[<i>label</i>] CALL k
Operands:	$0 \leq k \leq 255$
Operation:	$\begin{array}{l} (\text{PC}) + 1 \rightarrow \text{TOS}; \\ k \rightarrow \text{PC} < 7:0 >; \\ (\text{STATUS} < 6:5 >) \rightarrow \text{PC} < 10:9 >; \\ 0 \rightarrow \text{PC} < 8 > \end{array}$
Status Affected:	None
Encoding:	1001 kkkk kkkk
Description.	address (PC+1) is pushed onto the stack. The eight bit immediate address is loaded into PC bits <7:0>. The upper bits PC<10:9> are loaded from STATUS<6:5>, PC<8> is cleared. CALL is a two- cycle instruction.
Words:	1
Cycles:	2
Example:	HERE CALL THERE
Before Instru PC = After Instruct PC = TOS =	ction address (HERE) ion address (THERE) address (HERE + 1)

CLRE	Clear f
	Cical I

Syntax:	[label]	CLRF f		
Operands:	$0 \le f \le 31$	l		
Operation:	$\begin{array}{c} 00h \rightarrow (f \\ 1 \rightarrow Z \end{array}$);		
Status Affected:	Z			
Encoding:	0000	011f	ffff	
Description:	The cont cleared a	ents of re and the Z	gister 'f' a bit is set.	are
Words:	1			
Cycles:	1			
Example:	CLRF	FLAG_RE	G	
Before Instru FLAG_RI After Instructi	ction EG = Ion	0x5A		
FLAG_RI	EG =	0x00		
Z	=	1		

CLRW	Clear W
Syntax:	[label] CLRW
Operands:	None
Operation:	$\begin{array}{l} 00h \rightarrow (W); \\ 1 \rightarrow Z \end{array}$
Status Affected:	Z
Encoding:	0000 0100 0000
Description:	The W register is cleared. Zero bit (Z) is set.
Words:	1
Cycles:	1
Example:	CLRW
VV = After Instruct W = Z =	= 0x5A tion = 0x00 = 1
CLRWDT	Clear Watchdog Timer
CLRWDT Syntax:	Clear Watchdog Timer
CLRWDT Syntax: Operands:	Clear Watchdog Timer [<i>label</i>] CLRWDT None
CLRWDT Syntax: Operands: Operation:	Clear Watchdog Timer [<i>label</i>] CLRWDT None $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow \overline{TO};$ $1 \rightarrow \overline{PD}$
CLRWDT Syntax: Operands: Operation: Status Affected:	Clear Watchdog Timer [<i>label</i>] CLRWDT None $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow \overline{TO};$ $1 \rightarrow \overline{PD}$ $\overline{TO}, \overline{PD}$
CLRWDT Syntax: Operands: Operation: Status Affected: Encoding:	Clear Watchdog Timer[label]CLRWDTNone $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow TO;$ $1 \rightarrow PD$ \overline{TO}, PD 0000 0000
CLRWDT Syntax: Operands: Operation: Status Affected: Encoding: Description:	Clear Watchdog Timer[label] CLRWDTNone $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow TO;$ $1 \rightarrow PD$ TO, PD 0000 0100 The CLRWDT instruction resets theWDT. It also resets the prescaler, ifthe prescaler is assigned to theWDT and not Timer0. Status bitsTO and PD are set.
CLRWDT Syntax: Operands: Operation: Status Affected: Encoding: Description: Words:	Clear Watchdog Timer [<i>label</i>] CLRWDT None $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow TO;$ $1 \rightarrow PD$ TO, PD 0000 0000 0100 The CLRWDT instruction resets the WDT. It also resets the prescaler, if the prescaler is assigned to the WDT and not Timer0. Status bits TO and PD are set. 1
CLRWDT Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles:	Clear Watchdog Timer [label] CLRWDT None $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow TO;$ $1 \rightarrow PD$ TO, PD 0000 0000 0100 The CLRWDT instruction resets the WDT. It also resets the prescaler, if the prescaler is assigned to the WDT and not Timer0. Status bits TO and PD are set. 1 1
CLRWDT Syntax: Operands: Operation: Status Affected: Encoding: Description: Words: Cycles: Example:	Clear Watchdog Timer [<i>label</i>] CLRWDT None $00h \rightarrow WDT;$ $0 \rightarrow WDT$ prescaler (if assigned); $1 \rightarrow TO;$ $1 \rightarrow PD$ TO, PD 0000 0000 0100 The CLRWDT instruction resets the WDT. It also resets the prescaler, if the prescaler is assigned to the WDT and not Timer0. Status bits TO and PD are set. 1 1 CLRWDT

After Instruction		
WDT counter	=	0x00
WDT prescaler	=	0
TO	=	1
PD	=	1

MOVWF	Move W	to f					
Syntax:	[label]	MOVWF	f				
Operands:	$0 \le f \le 31$						
Operation:	$(W) \rightarrow (f)$)					
Status Affected:	None						
Encoding:	0000	001f	ffff				
Description:	Move data from the W register to register 'f'.						
Words:	1						
Cycles:	1						
Example:	MOVWF	TEMP_RE	lG				
Before Instru TEMP_F W After Instructi TEMP_F W	ction REG = on REG = =	0xFF 0x4F 0x4F 0x4F 0x4F					

NOP	No Operation						
Syntax:	[label]	NOP					
Operands:	None						
Operation:	No operation						
Status Affected:	None						
Encoding:	0000	0000	0000]			
Description:	No opera	ation.		-			
Words:	1						
Cycles:	1						
Example:	NOP						

OPTION	Load OPTION Register							
Syntax:	[label]	OPTIO	N					
Operands:	None							
Operation:	$(W) \rightarrow C$	PTION						
Status Affected:	None							
Encoding:	0000	0000	0010					
Description:	The content of the W register is loaded into the OPTION register.							
Words:	1							
Cycles:	1							
Example	OPTION							
Before Instruction								
W	= 0x	07						
After Instructi	on							
OPTION	= 0x	07						

RETLW	Return w	ith Liter	al in W	
Syntax:	[label]	RETLW	k	
Operands:	$0 \leq k \leq 25$	5		
Operation:	$k \rightarrow (W);$ TOS $\rightarrow P$	С		
Status Affected:	None			
Encoding:	1000	kkkk	kkkk	
Description:	The W reg eight bit lit counter is the stack (is a two-cy	gister is l teral 'k'. loaded f the retur ycle insti	oaded wi The progi from the t n address ruction.	th the ram op of s). This
Words:	1			
Cycles:	2			
Example:	CALL TAN	BLE ;W ;tal ;val ;W r ;val	contai: ole off lue. now has lue.	ns set table
TABLE	ADDWF PC RETLW k: RETLW k:	C ;W = 1 ;Beg 2 ; n ; En	= offse gin tab nd of t	t le able
Before Instru	ction			
W	= 0x0)7		
After Instruct	ion .	(1.5		
VV	= valu	ue of k8		

12.0 ELECTRICAL CHARACTERISTICS - PIC16C54A

Absolute Maximum Ratings^(†)

Ambient Temperature under bias	–55°C to +125°C
Storage Temperature	65°C to +150°C
Voltage on VDD with respect to VSS	0V to +7.5V
Voltage on MCLR with respect to Vss ⁽¹⁾	0V to +14V
Voltage on all other pins with respect to Vss	0.6V to (VDD + 0.6V)
Total power dissipation ⁽²⁾	800 mW
Max. current out of Vss pin	150 mA
Max. current into VDD pin	100 mA
Max. current into an input pin (T0CKI only)	±500 μA
Input clamp current, Iik (VI < 0 or VI > VDD)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VDD)	±20 mA
Max. output current sunk by any I/O pin	
Max. output current sourced by any I/O pin	
Max. output current sourced by a single I/O port (PORTA, B or C)	40 mA
Max. output current sunk by a single I/O port (PORTA, B or C)	50 mA

- **Note 1:** Voltage spikes below Vss at the $\overline{\text{MCLR}}$ pin, inducing currents greater than 80 mA, may cause latch-up. Thus, a series resistor of 50 to 100 Ω should be used when applying a "low" level to the $\overline{\text{MCLR}}$ pin rather than pulling this pin directly to Vss.
 - **2:** Power Dissipation is calculated as follows: Pdis = VDD x {IDD $-\Sigma$ IOH} + Σ {(VDD VOH) x IOH} + Σ (VOL x IOL)

† NOTICE: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.



FIGURE 14-22: PORTA, B AND C IOL vs. VoL, VDD = 5 V



NOTES:







17.1 DC Characteristics:PIC16C54C/C55A/C56A/C57C/C58B-04, 20 (Commercial, Industrial) PIC16LC54C/LC55A/LC56A/LC57C/LC58B-04 (Commercial, Industrial) PIC16CR54C/CR56A/CR57C/CR58B-04, 20 (Commercial, Industrial) PIC16LCR54C/LCR56A/LCR57C/LCR58B-04 (Commercial, Industrial)

5X R5X ercial, Indu	ustrial)	$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \end{array}$					
PIC16C5X PIC16CR5X (Commercial, Industrial)			$\begin{array}{ll} \mbox{Standard Operating Conditions (unless otherwise specified)} \\ \mbox{Operating Temperature} & 0^{\circ}C \leq TA \leq +70^{\circ}C \mbox{ for commercial} \\ -40^{\circ}C \leq TA \leq +85^{\circ}C \mbox{ for industrial} \end{array}$				
Symbol	Characteristic/Device	Min	Тур†	Max	Units	Conditions	
IDD	Supply Current ^(2,3)						
	PIC16LC5X		0.5	2.4	mA	Fosc = 4.0 MHz, VDD = 5.5V, XT and	
			11	27	μA	RC modes	
						FOSC = 32 kHz , VDD = 2.5V, LP mode,	
			14	35	μA	Commercial Ease $= 22 \text{ kHz}$ Vpp $= 2.5 \text{ // LP mode}$	
						Industrial	
	PIC16C5X	_	1.8	2.4	mA	Fosc = 4 MHz, VDD = 5.5V, XT and RC	
			2.6	3.6*	mA	modes	
		—	4.5	16	mA	FOSC = 10 MHz, VDD = 3.0V, HS mode	
			14	32	μA	FOSC = 20 MHz, VDD = 5.5 V, HS mode	
			47	40		POSC = 32 kHz, VDD = 3.0 V, LP mode,	
		_	17	40	μA	Commercial	
						Industrial	
	5X R5X ercial, Indu Symbol	5X R5X ercial, Industrial) X 5X ercial, Industrial) Symbol Characteristic/Device IDD Supply Current ^(2,3) PIC16LC5X PIC16C5X	SX Stand: Opera R5X Opera ercial, Industrial) Stand: Opera Symbol Characteristic/Device Min IDD Supply Current ^(2,3) — PIC16LC5X — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — — —	SX R5X ercial, Industrial) Standard Ope Operating Tem Operating Tem Operating Tem Symbol Characteristic/Device Min Typ† IDD Supply Current ^(2,3) Min Typ† IDD Supply Current ^(2,3) 0.5 IDD PIC16LC5X — 0.5 IDD PIC16LC5X — 14 IDD 14 14 IDD 14 14	SX R5X ercial, Industrial) Standard Operating Operating Temperatu Operating Temperatu Symbol Characteristic/Device Min Typ† Max IDD Supply Current ^(2,3) 91C16LC5X 0.5 2.4 11 27 14 35 PIC16C5X 1.8 2.4 14 35 14 32 14 32 14 32 14 32 17 40	5X Standard Operating Condit Operating Temperature 6x Standard Operating Condit Operating Temperature 6x Standard Operating Condit Operating Temperature 5x Standard Operating Condit Operating Temperature 5x Standard Operating Condit Operating Temperature Symbol Characteristic/Device Min Typ† Max Units IDD Supply Current ^(2,3) PIC16LC5X — 0.5 2.4 mA IDD PIC16LC5X — 11 27 µA IDD PIC16C5X — 1.8 2.4 mA IDD PIC16C5X — 1.8 2.4 mA IDD IDD PIC16C5X — 1.8 2.4 mA IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD IDD <t< td=""></t<>	

Legend: Rows with standard voltage device data only are shaded for improved readability.

* These parameters are characterized but not tested.

- † Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.
- Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
 - 3: Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in k Ω .

17.2 DC Characteristics: PIC16C54C/C55A/C56A/C57C/C58B-04E, 20E (Extended) PIC16CR54C/CR56A/CR57C/CR58B-04E, 20E (Extended)

PIC16C54C/C55A/C56A/C57C/C58B-04E, 20E PIC16CR54C/CR56A/CR57C/CR58B-04E, 20E (Extended)				Standard Operating Conditions (unless otherwise specified)Operating Temperature $-40^{\circ}C \le TA \le +125^{\circ}C$ for extended					
Param No.	Symbol	Characteristic	Min	Тур†	Max	Units	Conditions		
D001	Vdd	Supply Voltage	3.0 4.5		5.5 5.5	V V	RC, XT, LP, and HS mode from 0 - 10 MHz from 10 - 20 MHz		
D002	Vdr	RAM Data Retention Voltage ⁽¹⁾	—	1.5*	—	V	Device in SLEEP mode		
D003	VPOR	VDD start voltage to ensure Power-on Reset	—	Vss	—	V	See Section 5.1 for details on Power-on Reset		
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	_	—	V/ms	See Section 5.1 for details on Power-on Reset		
D010	IDD	Supply Current ⁽²⁾ XT and RC ⁽³⁾ modes HS mode	_	1.8 9.0	3.3 20	mA mA	Fosc = 4.0 MHz, Vdd = 5.5V Fosc = 20 MHz, Vdd = 5.5V		
D020	IPD	Power-down Current ⁽²⁾		0.3 10 12 4.8 18 26	17 50* 60* 31* 68* 90*	μΑ μΑ μΑ μΑ μΑ	VDD = 3.0V, WDT disabled VDD = 4.5V, WDT disabled VDD = 5.5V, WDT disabled VDD = 3.0V, WDT enabled VDD = 4.5V, WDT enabled VDD = 5.5V, WDT enabled		

These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C, unless otherwise stated. These parameters are for design guidance only, and are not tested.

- Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as bus loading, oscillator type, bus rate, internal code execution pattern, and temperature also have an impact on the current consumption.
 - a) The test conditions for all IDD measurements in active Operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tristated, pulled to Vss, TOCKI = VDD, MCLR = VDD; WDT enabled/ disabled as specified.
 - b) For standby current measurements, the conditions are the same, except that the device is in SLEEP mode. The power-down current in SLEEP mode does not depend on the oscillator type.
 - **3:** Does not include current through REXT. The current through the resistor can be estimated by the formula: IR = VDD/2REXT (mA) with REXT in kΩ.

28-Lead Skinny Plastic Dual In-line (SP) - 300 mil (PDIP)





в

	Units	INCHES*			MILLIMETERS		
Dimension L	imits	MIN	NOM	MAX	MIN NOM		MAX
Number of Pins	n		28			28	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.140	.150	.160	3.56	3.81	4.06
Molded Package Thickness	A2	.125	.130	.135	3.18	3.30	3.43
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	Е	.300	.310	.325	7.62	7.87	8.26
Molded Package Width	E1	.275	.285	.295	6.99	7.24	7.49
Overall Length	D	1.345	1.365	1.385	34.16	34.67	35.18
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.040	.053	.065	1.02	1.33	1.65
Lower Lead Width	В	.016	.019	.022	0.41	0.48	0.56
Overall Row Spacing §	eB	.320	.350	.430	8.13	8.89	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

* Controlling Parameter § Significant Characteristic

eВ

Dimension D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed

.010" (0.254mm) per side.

JEDEC Equivalent: MO-095

Drawing No. C04-070

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Notes:

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